

74F413 64 x 4 First-In First-Out Buffer Memory with Parallel I/O

General Description

The 'F413 is an expandable fall-through type high-speed First-In First-Out (FIFO) buffer memory organized as 64 words by four bits. The 4-bit input and output registers record and transmit, respectively, asynchronous data in parallel form. Control pins on the input and output allow for hand-shaking and expansion. The 4-bit wide, 62-bit deep fall-through stack has self-contained control logic.

Features

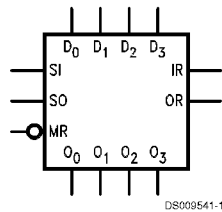
- Separate input and output clocks
- Parallel input and output
- Expandable without external logic
- 15 MHz data rate
- Supply current 160 mA max
- Available in SOIC, (300 mil only)

Ordering Code:

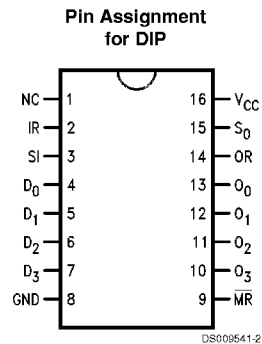
Commercial	Military	Package Number	Package Description
74F413PC		N16E	16-Lead (0.300" Wide) Molded Dual-In-Line
	54F413DM (Note 1)	J16A	16-Lead Ceramic Dual-In-Line

Note 1: Military grade device with environmental and burn-in processing. Use suffix = DMOB.

Logic Symbol



Connection Diagram



Unit Loading/Fan Out

Pin Names	Description	54F/74F	
		U.L.	Input I_{IH}/I_{IL}
		HIGH/LOW	Output I_{OH}/I_{OL}
D ₀ –D ₃	Data Inputs	1.0/0.667	20 μ A/–0.4 mA
O ₀ –O ₃	Data Outputs	50/13.3	–1 mA/8 mA
IR	Input Ready	1.0/0.667	20 μ A/–0.4 mA
SI	Shift In	1.0/0.667	20 μ A/–0.4 mA
SO	Shift Out	1.0/0.667	20 μ A/–0.4 mA
OR	Output Ready	1.0/0.667	20 μ A/–0.4 mA
\overline{MR}	Master Reset	1.0/0.667	20 μ A/–0.4 mA

Functional Description

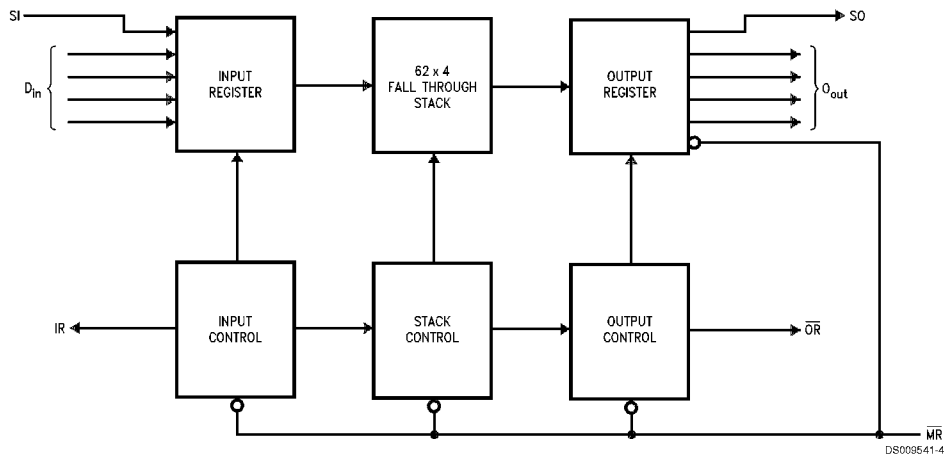
Data Input— Data is entered into the FIFO on D₀–D₃ inputs. To enter data the Input Ready (IR) should be HIGH, indicating that the first location is ready to accept data. Data then present at the four data inputs is entered into the first location when the Shift In (SI) is brought HIGH. An SI HIGH signal causes the IR to go LOW. Data remains at the first location until SI is brought LOW. When SI is brought LOW and the FIFO is not full, IR will go HIGH, indicating that more room is available. Simultaneously, data will propagate to the second location and continue shifting until it reaches the output stage or a full location. If the memory is full, IR will remain LOW.

Data Transfer— Once data is entered into the second cell, the transfer of any full cell to the adjacent (downstream) empty cell is automatic, activated by an on-chip control. Thus data will stack up at the end of the device while empty locations will “bubble” to the front. The t_{PT} parameter defines the time required for the first data to travel from input to the output of a previously empty device.

Data Output— Data is read from the O₀–O₃ outputs. When data is shifted to the output stage, Output Ready (OR) goes HIGH, indicating the presence of valid data. When the OR is HIGH, data may be shifted out by bringing the Shift Out (SO) HIGH. A HIGH signal at SO causes the OR to go LOW. Valid data is maintained while the SO is HIGH. When SO is brought LOW, the upstream data, provided that stage has valid data, is shifted to the output stage. When new valid data is shifted to the output stage, OR goes HIGH. If the FIFO is emptied, OR stays LOW, and O₀–O₃ remains as before, i.e., data does not change if FIFO is empty.

Input Ready and Output Ready may also be used as status signals indicating that the FIFO is completely full (Input Ready stays LOW for at least t_{PT}) or completely empty (Output Ready stays LOW for at least t_{PT}).

Block Diagram



Absolute Maximum Ratings (Note 2)

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +175°C
Plastic	-55°C to +150°C
V _{CC} Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 3)	-0.5V to +7.0V
Input Current (Note 3)	-30 mA to +5.0 mA
Voltage Applied to Output in HIGH State (with V _{CC} = 0V)	
Standard Output	-0.5V to V _{CC}
3-STATE Output	-0.5V to +5.5V
Current Applied to Output in LOW State (Max)	twice the rated I _{OL} (mA)

Recommended Operating Conditions

Free Air Ambient Temperature	
Military	-55°C to +125°C
Commercial	0°C to +70°C
Supply Voltage	
Military	+4.5V to +5.5V
Commercial	+4.5V to +5.5V

Note 2: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 3: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter	54F/74F			Units	V _{CC}	Conditions
		Min	Typ	Max			
V _{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage			-1.5	V	Min	I _{IN} = -18 mA
V _{OH}	Output HIGH Voltage	54F 10% V _{CC}	2.4		V	Min	I _{OH} = -1 mA
		74F 10% V _{CC}	2.4				I _{OH} = -1 mA
		74F 5% V _{CC}	2.7				I _{OH} = -1 mA
V _{OL}	Output LOW Voltage	54F 10% V _{CC}		0.5	V	Min	I _{OL} = 8 mA
		74F 10% V _{CC}		0.5			I _{OL} = 8 mA
I _{IH}	Input HIGH Current	54F		20.0	μA	Max	V _{IN} = 2.7V
		74F		5.0			
I _{BVI}	Input HIGH Current Breakdown Test	54F		100	μA	Max	V _{IN} = 7.0V
		74F		7.0			
I _{CEx}	Output HIGH Leakage Current	54F		250	μA	Max	V _{OUT} = V _{CC}
		74F		50			
V _{ID}	Input Leakage Test	74F	4.75		V	0.0	I _{ID} = 1.9 μA All Other Pins Grounded
I _{OD}	Output Leakage Circuit Current	74F		3.75	μA	0.0	V _{ID} = 150 mV All Other Pins Grounded
I _{IL}	Input LOW Current			-0.4	mA	Max	V _{IN} = 0.5V
I _{OS}	Output Short-Circuit Current		-20	-130	mA	Max	V _{OUT} = 0V
I _{CCH}	Power Supply Current		115	160	mA	Max	V _O = HIGH

AC Electrical Characteristics

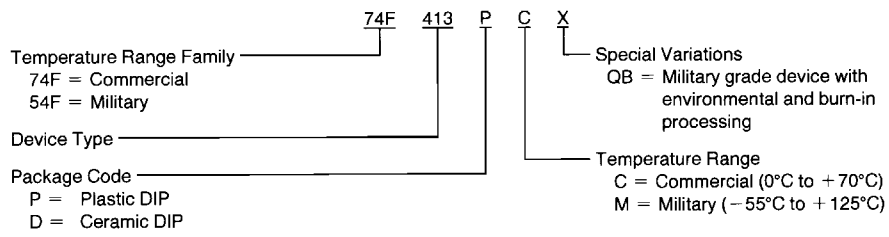
Symbol	Parameter	74F			54F		74F		Units
		T _A = +25°C V _{CC} = +5.0V C _L = 50 pF			T _A , V _{CC} = MII C _L = 50 pF		T _A , V _{CC} = Com C _L = 50 pF		
		Min	Typ	Max	Min	Max	Min	Max	
f _{max}	Shift In Rate	10			8.0		10		MHz
f _{max}	Shift Out Rate	10			8.0		10		MHz
t _{PLH}	Propagation Delay	1.5		44.0	1.5	50.0	1.5	48.0	ns
t _{PHL}	Shift In to IR	1.5		31.0	1.5	37.0	1.5	35.0	ns
t _{PLH}	Propagation Delay	1.5		52.0	1.5	57.0	1.5	55.0	ns
t _{PHL}	Shift Out to OR	1.5		31.0	1.5	37.0	1.5	35.0	ns
t _{PLH}	Propagation Delay	1.5		46.0	1.5	52.0	1.5	50.0	ns
t _{PHL}	Output Data Delay	1.5		34.0	1.5	39.0	1.5	37.0	ns
t _{PLH}	Propagation Delay Master Reset to IR	1.5		27.0	1.5	33.0	1.5	31.0	ns
t _{PLH}	Propagation Delay Master Reset to OR	1.5		30.0	1.5	34.0	1.5	32.0	ns

AC Operating Requirements

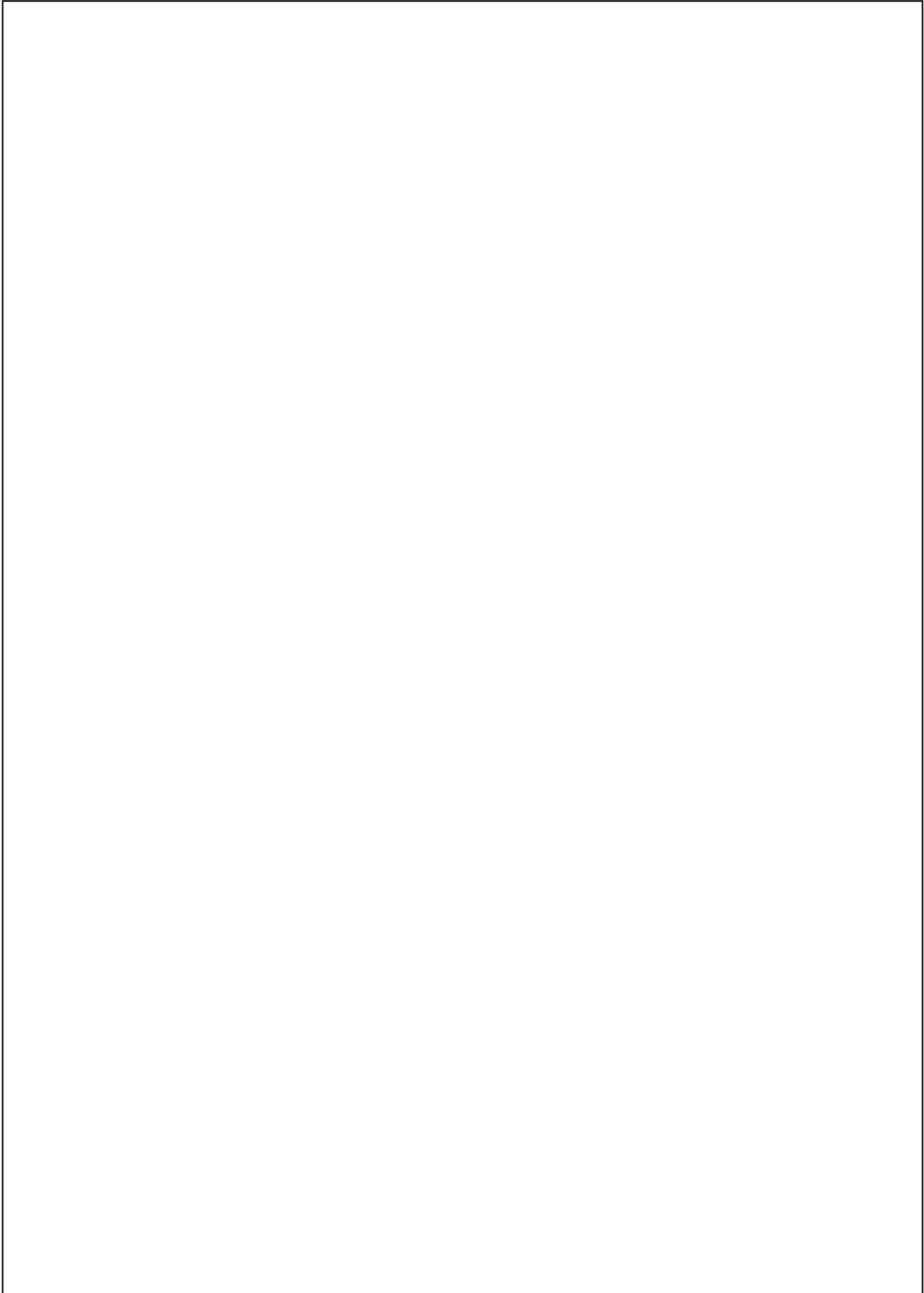
Symbol	Parameter	74F		54F		74F		Units
		T _A = +25°C V _{CC} = +5.0V		T _A , V _{CC} = MII		T _A , V _{CC} = Com		
		Min	Max	Min	Max	Min	Max	
t _s (H)	Setup Time, HIGH or LOW	1.0		1.0		1.0		ns
t _s (L)	D _n to SI	1.0		1.0		1.0		
t _h (H)	Hold Time, HIGH or LOW	10.0		10.0		10.0		ns
t _h (L)	D _n to SI	10.0		10.0		10.0		
t _w (H)	Shift In Pulse Width	5.0		5.0		5.0		ns
t _w (L)	HIGH or LOW	10.0		10.0		10.0		
t _w (H)	Shift Out Pulse Width	7.5		8.5		7.5		ns
t _w (L)	HIGH or LOW	10.0		10.0		10.0		
t _w (H)	Input Ready Pulse Width, HIGH	7.5		8.5		7.5		ns
t _w (L)	Output Ready Pulse Width, LOW	5.0		5.0		5.0		ns
t _w (L)	Master Reset Pulse Width, LOW	10.0		10.0		10.0		ns
t _{rec}	Recovery Time, MR to SI	32.0		35.0		35.0		ns
t _{PT}	Data Throughput Time		0.9		1.0		1.0	μs

Ordering Information

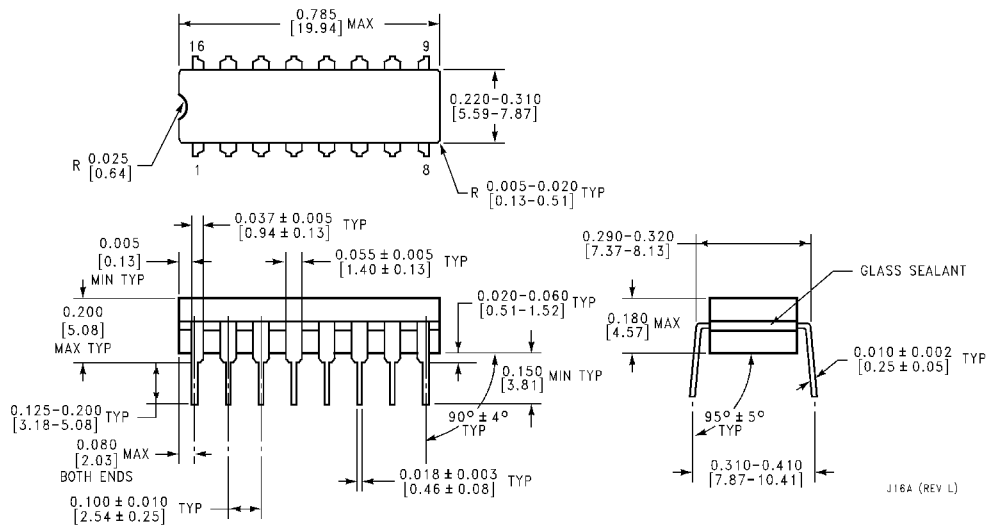
The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



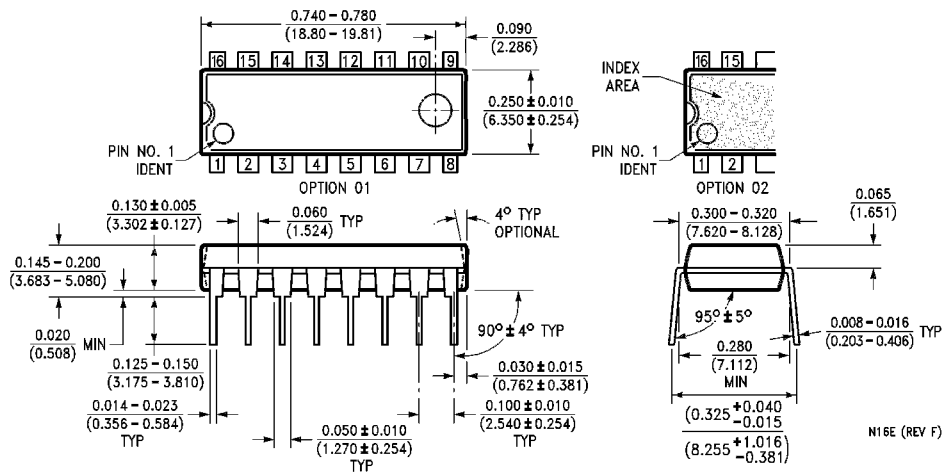
DS009541-5



Physical Dimensions inches (millimeters) unless otherwise noted



**16-Lead Ceramic Dual-In-Line Package (D)
Package Number J16A**



**16-Lead (0.300" Wide) Molded Dual-In-Line Package (P)
Package Number N16E**

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Fairchild Semiconductor Corporation Americas
Customer Response Center
Tel: 1-888-522-5372

www.fairchildsemi.com

Fairchild Semiconductor Europe
Fax: +49 (0) 1 80-530 85 86
Email: europa.support@nsc.com
Deutsch Tel: +49 (0) 8 141-35-0
English Tel: +44 (0) 1 793-85-68-56
Italy Tel: +39 (0) 2 57 5631

Fairchild Semiconductor Hong Kong Ltd.
13th Floor, Straight Block,
Ocean Centre, 5 Canton Rd.
Tsimshatsui, Kowloon
Hong Kong
Tel: +852 2737-7200
Fax: +852 2314-0061

National Semiconductor Japan Ltd.
Tel: 81-3-5620-6175
Fax: 81-3-5620-6179